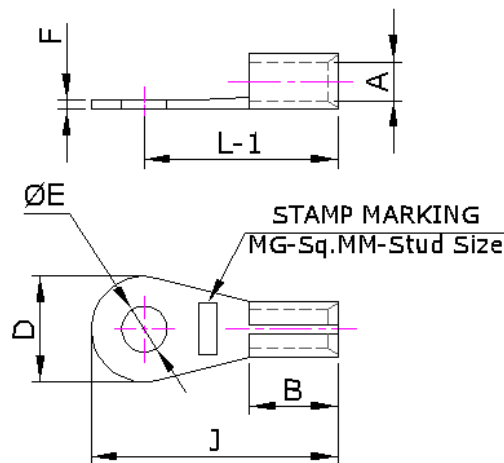


Open-Close Type Soldering Lug (MGOC Series)



Technical Specification

Material: ETP Copper IS 1897:1983

Surface: Tin-plated to protect against corrosion

Minimum operating temperature: -50 °C

Maximum operating temperature: 150 °C

Reference standard: Indian Standards

Features

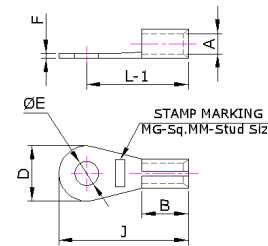
- Annealed material optimizes material and crimping properties
- ETP Electrolytic Grade Copper.
- Tin-plated 5 micron plus to protect against corrosion.
- Crack free crimping.
- Bur free connection surface.
- Lowest millivolt drop for DC current application.
- Simple and safe connection.
- Terminate power cables in high-voltage applications.
- Provided with inspection hole to ensure the conductor has been fully inserted before crimping is done.
- Flat contact surface to avoid hotspot.

Open-Close Type Soldering Lug (MGOC Series)

COPPER OPEN-CLOSE TYPE SOLDERING TERMINAL

MATERIAL ETP COPPER IS : 1897:2008

SURFACE: TIN PLATED



Size mm ²	E	A	D	F	B	L-1	J	MG CAT NO.	Crimping Tools Code
1.5	4.2	1.6	7	0.8	5	11.5	15	MGOC-371	
2.5	5.2	2.3	9	0.8	6	13.5	18	MGOC-372	
4	5.2	2.8	9	1	6	15.5	20	MGOC-373	
6	6.5	3.6	12	1	7	18	24	MGOC-374	
10	6.5	4.4	12	1	9	21	27	MGOC-375	
16	8.2	5.4	15	1.2	11	24.5	32	MGOC-376	
25	8.2	7	15	1.6	14	28.5	36	MGOC-377	
35	8.2	8	18	1.6	15	32	41	MGOC-378	
50	10.2	9.5	24	1.8	18	38	50	MGOC-379	
70	10.2	11.8	28	2	23	44	58	MGOC-380	
95	12.7	13.5	32	2.6	25	50	66	MGOC-381	
120	12.7	15.5	34	2.8	29	56	73	MGOC-382	
150	12.7	16.5	38	3.2	30	60	79	MGOC-383	
185	16.2	18.5	42	3.6	35	66	87	MGOC-384	
225	16.2	21	44	3.6	40	70	92	MGOC-385	

Open-Close Type Soldering Lug (MGOC Series)

Size mm ²	E	A	D	F	B	L-1	J	MG CAT NO.	Crimping Tools Code
240	16.2	22.5	48	4	42	76	100	MGOC-386	
300	20.3	25	54	4.5	45	83	110	MGOC-387	
400	20.3	29.5	62	5	54	94	125	MGOC-388	
500	20.3	32	62	5.4	58	106	137	MGOC-389	
625	20.3	36	70	5.4	65	113	148	MGOC-390	